# **EPISTAR**

# **ES-CASO512**

## AIGaInP ITO-top LED Chip

## > Mechanical Specification:

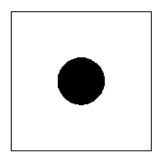
#### (1) Dimension

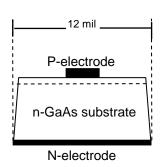
- Chip size: 12 mil x 12 mil (305±25 μm x 305±25 μm)

- Thickness: 6.7 mil (170±25  $\mu$ m) - P bonding pad: 4.6 mil (117±10  $\mu$ m)

#### (2) Metallization

Topside P electrode: Au alloyBackside N electrode: Au alloy





#### **Features:**

- · High luminous intensity
- · ITO layer on top

## **Applications:**

- · Outdoor display
- · Traffic signal

## > Electro-optical Characteristics at 25°C:

Parameter	Symbol		Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf1		If = 10μA	1.3	-	-	V
	Vf2		If = 20mA	-	2.0	2.4	V
Reverse Current	Ir		Vr = 10V	-	-	10	μΑ
Peak Wavelength	λр		If = 20mA	-	621	-	nm
Dominant Wavelength <sup>(1)</sup>	λd		If = 20mA	610	615	620	nm
Spectra Half-width	Δλ		If = 20mA	-	18	-	nm
Luminous Intensity <sup>(2)(3)</sup>	lv	E7	If = 20mA	110	-	-	- mcd
		E8		140	-	-	
		E9		170	-	-	
		E10		200	-	-	

Note:

This product is made and sold under one or more of the following patents: Taiwan Patent Certificate Nos.: 098998; 113696; 128153; 131010; 144415; 148677; 170789; 183481; 183846; U.S. Patent Nos.: 5,008,718; 5,164,798; 5,233,204; 5,789,768; 6,078,064; 6,057,562; 6,225,648; 6,552,367; 6,876,005, and any foreign counterparts.

<sup>(1)</sup> Basically, the wavelength span is 10nm; however, customers' special requirements are also welcome.

<sup>(2)</sup> Customers' special requirements are also welcome.

<sup>(3)</sup> Luminous intensity is measured by EPISTAR's equipment on bare chips.

# > Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25°C	≤ 50	mA
Reverse Voltage	Vr	Ta = 25°C	≤ 10	V
Junction Temperature	Тј	-	≤ 115	°C
	Tstg	Chip	-40 ~ +85	°C
Storage Temperature		Chip-on-tape/storage	5~35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	-	280(<10sec)	°C

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Printed Circuit Board (PCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED

## > Characteristic Curves:

Fig.1 – Relative luminous Intensity vs. Forward Current

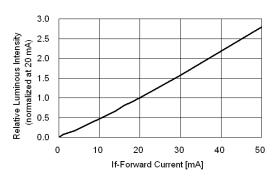
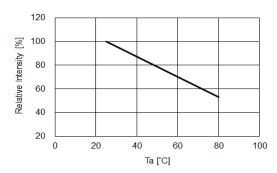


Fig.3 – Relative Intensity (@20mA) vs. Ambient Temperature



**Fig.5** – Dominant Wavelength (20mA) vs. Ambient Temperature

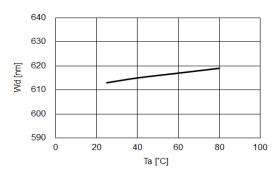
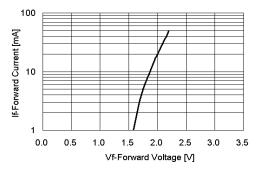
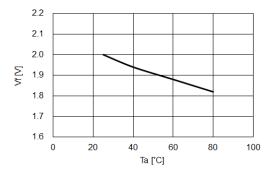


Fig.2 – Forward Current vs. Forward Voltage



**Fig.4** – Forward Voltage (@20mA) vs. Ambient Temperature



**Fig.6** – Maximum Driving Forward DC Current vs. Ambient Temperature (Derating based on Tj max. = 115°C)

